Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
100V	60mΩ@10V	14A
	70mΩ@4.5V	

合肥矽普半导体
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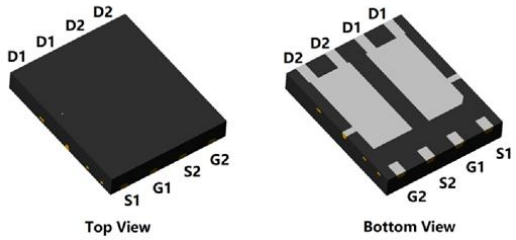
Feature

- Fast switching speed
- Reliable and Rugged
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

Applications

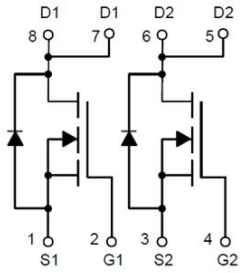
- Power management functions
- Industrial and Motor Drive application
- DC-DC Converters

Package

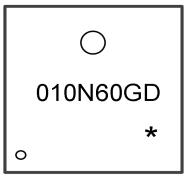


PDFN5x6-8L

Circuit diagram



Marking



010N60GD **:Device Code**

***** **:Month Code**

Order Information

Device	Package	Unit/Tape
SP010N60GDNK	PDFN5X6-8L	5000

Absolute maximum ratings (Ta=25℃ unless otherwise noted)

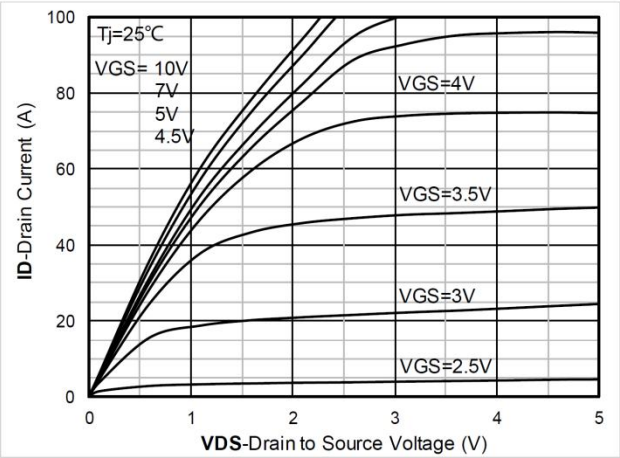
Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current (Tc=25℃)	I_D	14	A
Continuous Drain Current (Tc=100℃)	I_D	10	A
Pulsed Drain Current	I_{DM}	56	A
Single Pulse Avalanche Energy[1]	E_{AS}	9.8	mJ
Power Dissipation (Tc=25℃)	P_D	47.8	W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	2.6	℃/W
Storage Temperature Range	T_{STG}	-50 to 150	℃
Operating Junction Temperature Range	T_J	-50 to 150	℃

Electrical characteristics (Ta=25℃, unless otherwise noted)

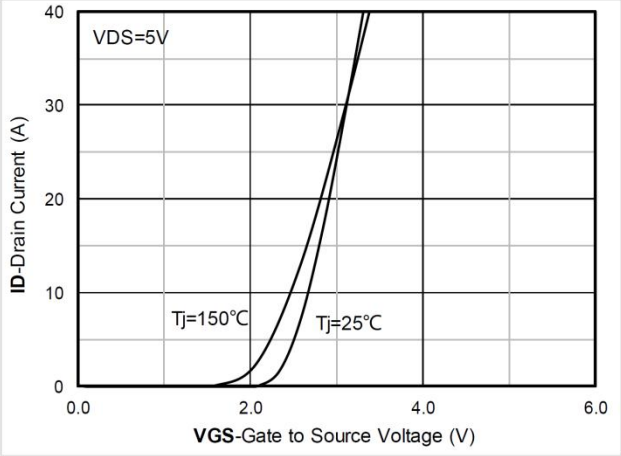
Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	VGS=0V , ID=250uA	100	---	---	V
Drain Cut-Off Current	I_{DSS}	VDS=100V , VGS=0V	---	---	1	uA
Gate Leakage Current	I_{GSS}	VGS=±20V , VDS=0V	---	---	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	VGS=VDS , ID =250uA	1	1.8	2.5	V
Drain-Source ON Resistance	$R_{DS(ON)}$	VGS=10V , ID=6A	---	60	75	mΩ
		VGS=4.5V , ID=4A	---	70	95	mΩ
Dynamic Characteristics						
Input Capacitance	C_{iss}	VDS=50V,VGS=0V,f=1MHZ	---	345	-	pF
Output Capacitance	C_{oss}		---	65	-	
Reverse Transfer Capacitance	C_{rss}		---	9.8	-	
Total Gate Charge	Q_g	VGS=10V,VDS=50V,ID=5.0A	---	6.1	-	nC
Gate-Source Charge	Q_{gs}		---	1.7	-	
Gate-Drain Charge	Q_{gd}		---	1.5	-	
Switching Characteristics						
Turn-On Delay Time	$t_{d(on)}$	VGS=10V,VDD=50V, ID=5.0A, RGEN=2Ω	---	8.8	-	nS
Rise Time	t_r		---	3.7	-	
Turn-Off Delay Time	$t_{d(off)}$		---	19	-	
Fall Time	t_f		---	7.5	-	
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V_{SD}	I_S = 1A, VGS = 0V	-	-	1.2	V
Maximum Body-Diode Continuous Current	I_S		-	-	10	A
Reverse Recovery Time	Trr	I_S=10A, di/dt=100A/us, TJ=25℃	-	16	-	nS
Reverse Recovery Charge	Qrr		-	18	-	nC

Note :
The test condition is VDD=50V,VGS=10V,L=0.1mH,RG=25Ω

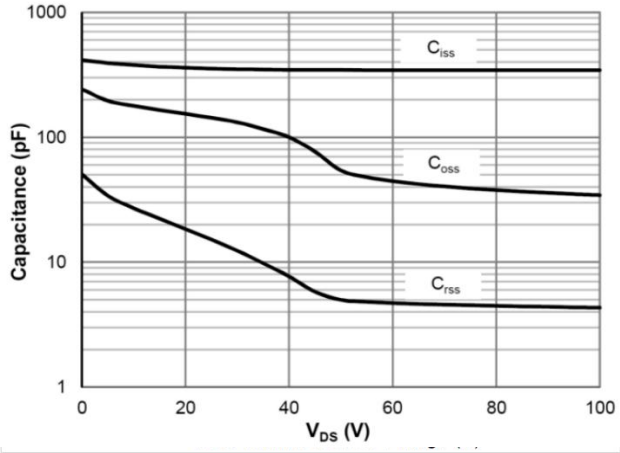
Typical Characteristics



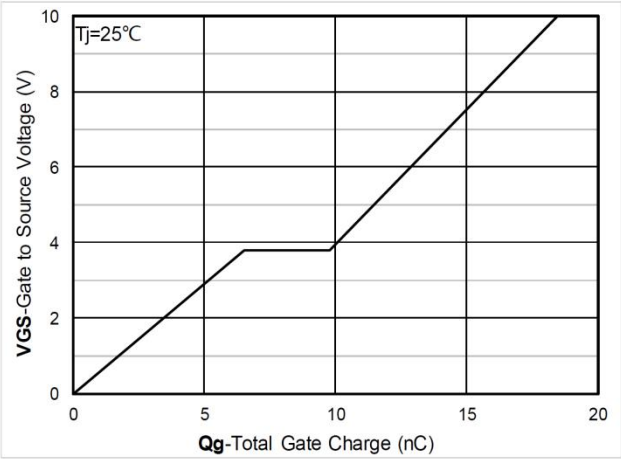
Output Characteristics



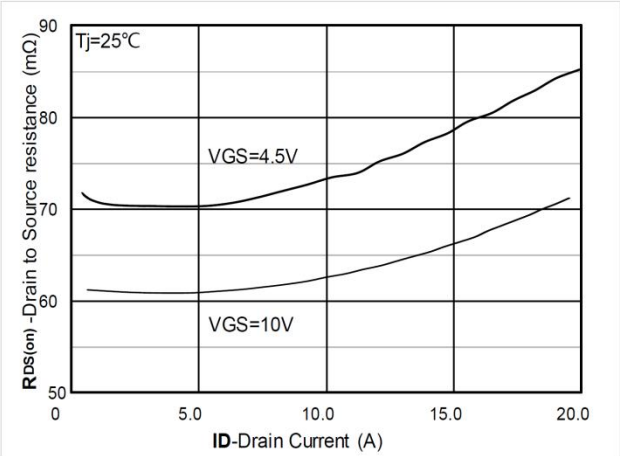
Transfer Characteristics



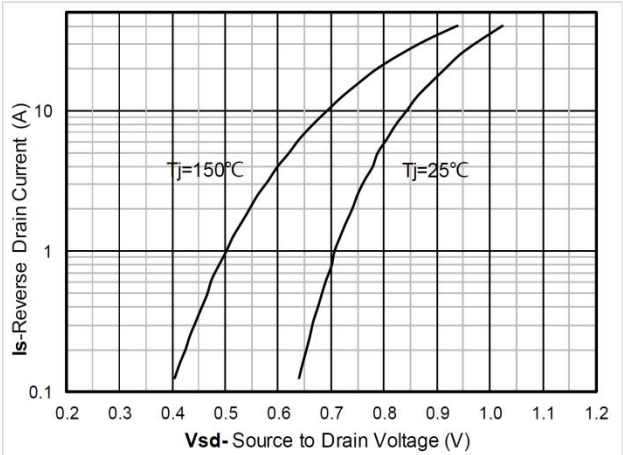
Capacitance Characteristics



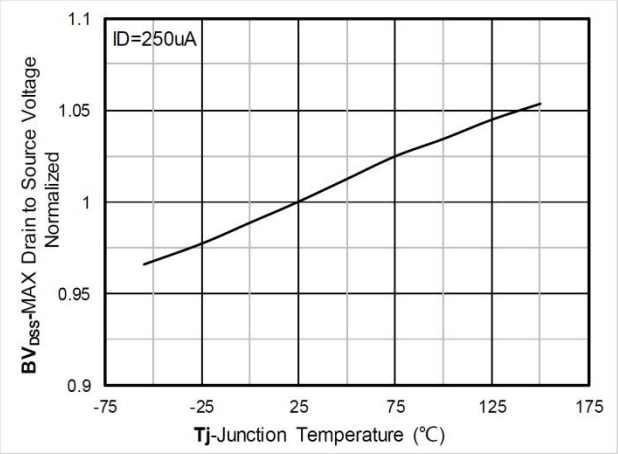
Gate Charge



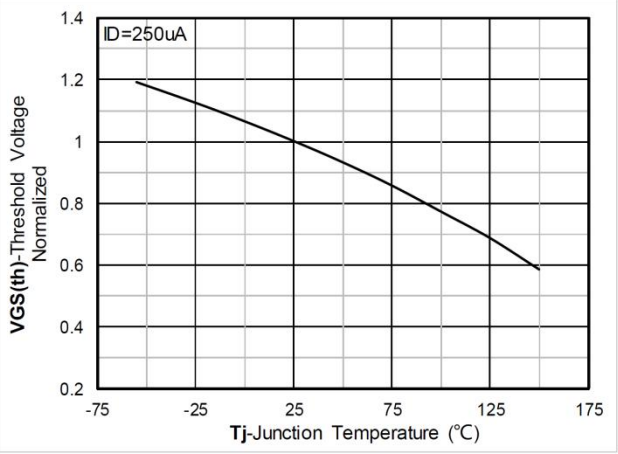
RDS(on) VS Drain Current



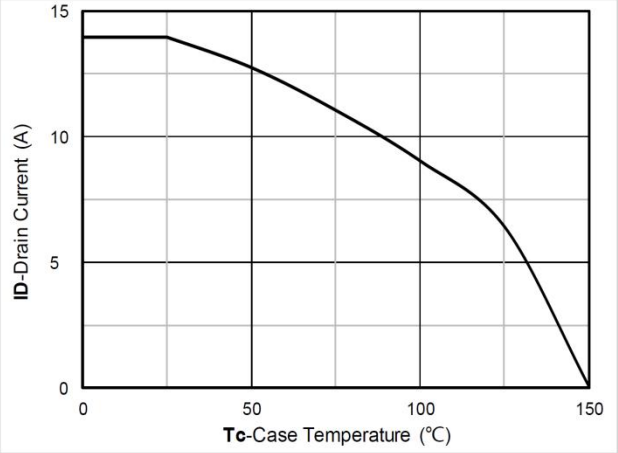
Forward characteristics of reverse diode



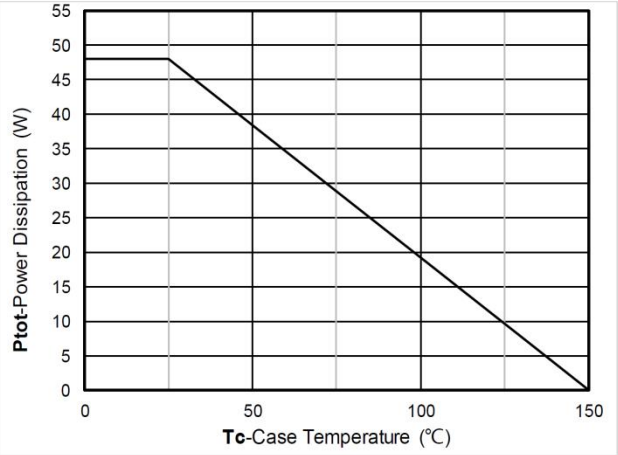
Normalized breakdown voltage



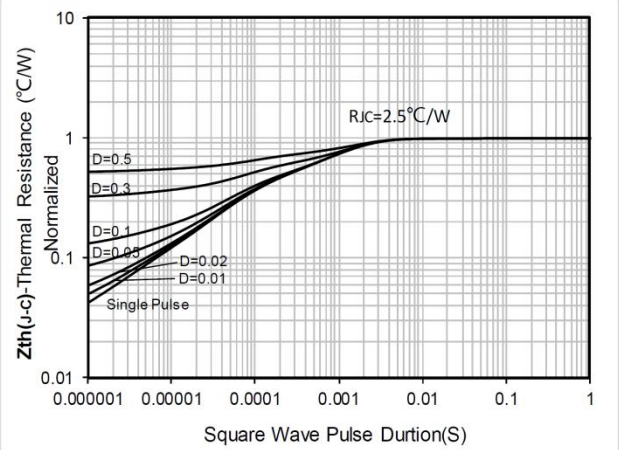
Normalized Threshold voltage



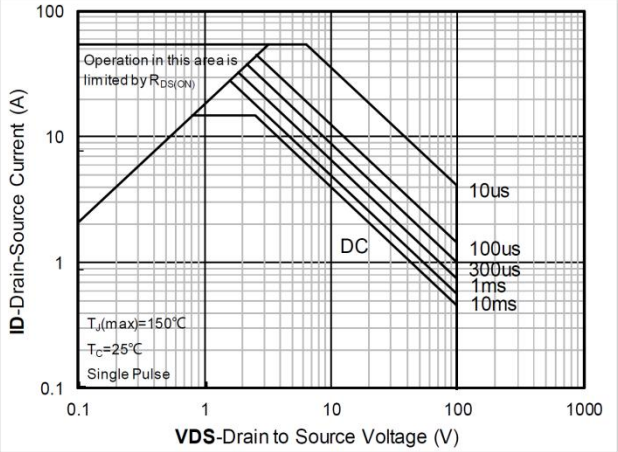
Current dissipation



Power dissipation

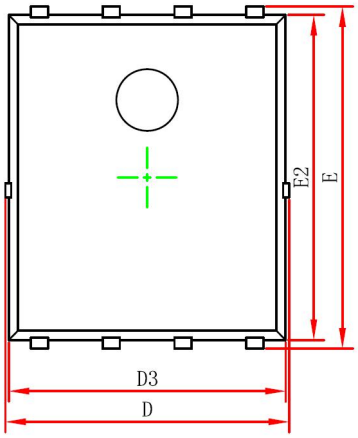


Maximum Transient Thermal Impedance

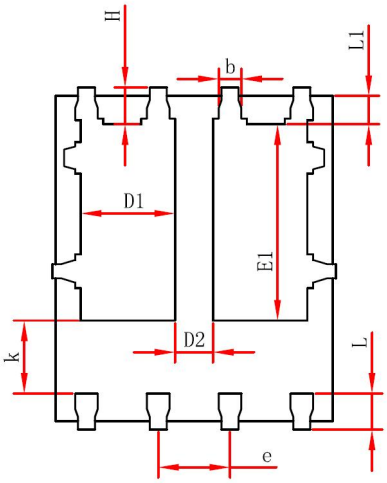


Safe Operation Area

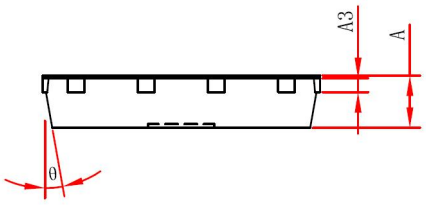
PDFN5x6-8L Package Information



Top View
[顶视图]



Bottom View
[背视图]



Side View
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254 REF.		0.010REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	1.470	1.870	0.058	0.074
D2	0.470	0.870	0.019	0.034
E1	3.375	3.575	0.133	0.141
D3	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°